ASSOCIATION CONNECTION ELECTRONICS INDUSTRI	Material Compos © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
upplier Inforr	nation															
Company name*			Company unique ID			J	Unique ID Authority					Response Date*				
nsemi												2025-06-04				
Contact Name			Title - Contact			I	Phone - Contact*					Email - Contact*				
Product-Env-Stew	ards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
uthorized Repres	entative*		Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stew	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Request	Requester Item Number		Mfr Item Number Mfr Item Name				Effective Dat	te Ver	rsion	Manufacturing Site		V	Weight*	UOM	Unit Type	
		NRTS810	RTS8100PFST3G 8A, 100V Trench Package		Schottky in T	O-277	2025-06-04	MYE			9	1.53	mg	Each		
Ianufacturing	Process Information	on														
Terminal Plating / Grid Array Material To			Ferminal Base Alloy J-STD-020 MSI			SL Rating	Peak Process Body Temperature Max Time at Peak				Temperati	ure Num	ber of Reflow Cy	cles		
Matte Tin (Sn) - annealed			CU Alloy 1			260	C 30			seconds 3						
omments																
vel 1 - maximum	time at peak temperature	e during sol	dering is 10-3	30 seconds												
or more informat	ion regarding material co	omposition p	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Isability and the Company's remedies for issues that arise regarding information the Supplier provides in this fo											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	7.88	mg	Supplier	Iron (Fe)	7439-89-6		0.0079	mg
			Supplier	Copper (Cu)	7440-50-8		7.8698	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0024	mg
Die	2.41	mg	Supplier	Silicon (Si)	7440-21-3		2.41	mg
Die Attach	1.6	mg	A	Lead (Pb)	7439-92-1	7a	1.52	mg
			Supplier	Tin (Sn)	7440-31-5		0.08	mg
Lead Frame	39.21	mg	Supplier	Iron (Fe)	7439-89-6		0.0392	mg
			Supplier	Copper (Cu)	7440-50-8		39.159	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0118	mg
Mold Compound-Black	35.69			Epoxy resin	proprietary data		4.8182	mg
			Supplier	Hardeness	Proprietary Data		2.1414	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1784	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		28.552	mg
Plating	4.74	mg	Supplier	Tin (Sn)	7440-31-5		4.74	mg